



The 27th Annual Conference of the IEEE Industrial Electronics Society
Hyatt Regency Tech Center, Denver, Colorado, USA
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IECON'01

Sponsored by: IEEE Industrial Electronics Society
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Special Session on Soft Computing Based Image Processing

organized and chaired by
Yasuhiro Ota, y-ota@tdc.minolta.co.jp

Call For Papers

Topics of interest include, but are not limited to:

- Pulse-coupled neural networks.
- Electrophotography process control based on soft computing.
- Human sensory perception oriented image processing.
- Fault diagnosis methods for imaging systems.
- Fuzzy-based image processing designs.
- Simulation tools for image signal analysis and design.
- New types of image signal processing with soft-computing technologies.
- Hardware/Software hybrid solutions with soft-computing technologies.
- General issues in image signal processing.
- Other topics related to the conference scope and/or of interest to the prospective conference participants.

Submission of Papers: The working language of the conference is English. Submit a full paper using the following layout: Page 1: title, authors' names, mailing address, phone, fax, and email of each author. Identify the contact author, preferred topical area, subject area and keywords. Page 2: title, authors' affiliations, 100-200 words abstract. Pages 3-8: full paper limited to 6 pages, including figures and references. Submit full papers in postscript or pdf format by e-mail to y-ota@tdc.minolta.co.jp.

Author's Schedule:

Deadline for Submission of Full Papers:

April 15, 2001

Notification of Acceptance:

June 10, 2001

Deadline for Submission of Final Manuscripts:

August 15, 2001

For general information please check the conference web page:

<http://sant.bradley.edu/~iecon01/>

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